High Density FPC Connector (0.3mm/0.4mm/0.5mm Pitch)

FH16 Series



■Features

1. High Density FPC Connector

The FH16 series is a fine pitch, zero insertion force (ZIF), right angle, bottom contact, connector compatible with flexible printed circuits (FPC) with a pitch of 0.3mm, 0.4mm, and 0.5mm and a recommended thickness of 0.295mm for single-sided or 0.306mm for double-sided. The FH16 provides a higher pin count given the same amount of board space than other manufacturers of similar product. With a large selection in pin density, the FH16 series greatly improves design flexibility.

FH16 : 0.3mm pitch 60, 80, and 90 contacts FH16M : 0.4mm pitch 80 and 96 contacts FH16H : 0.5mm pitch 50 contacts FH16P : 0.5mm pitch 64 contacts

2. Easy mounting on PCB

FH16 supports 0.3mm pitch cable but only requires a 0.6mm pitch pad layout on the PCB. The FH16's staggered pin design allows the mounting lead area to be twice as wide as the FPC contact area making it easier to place the connector on the board given the fine pitch of the contacts.

3. User Friendly Flip-Lock Design

The flip-lock (one-touch rotating type) ZIF structure secures the FPC connection with a single and light force. This design helps simplify assembly and repair work. When locking the FPC, the audible click assures the assembly worker of a steady FPC connection resulting in improved customer service.

4. Prevents FPC from escape and oblique mating

The FH16 series with its recommended FPC dimensions prevents the FPC from escape and oblique mating thereby securing a steady connection.

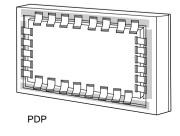
5. Compatible with Automatic Assembly Tooling

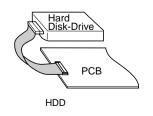
Embossed tape packaging allows for automatic placement onto the PCB.

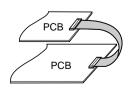
Applications

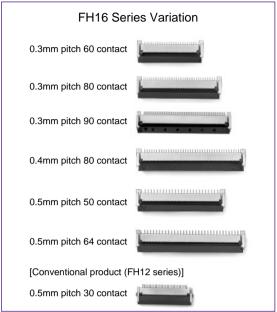
Notebook computers, printers, PDAs, digital cameras and other compact devices for interconnecting the main circuit board with the LCD,PDP(Plasma Display),HDD or other device.

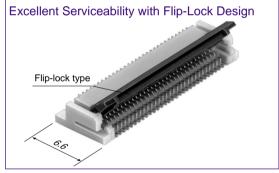














■Product Specifications

	Pitch	0.3mm	0.4mm	0.5mm	Operating Temperature Range: −40°C to +70°C	Storage Temperature Range: −10°C to +50°C
Ratir	current rating	0.15A	0.3A	0.4A	Operating Relative Humidity: Relative humidity 90% max	Storage Relative Humidity: Relative humidity 90% max
	Voltage rating	30V AC	50V AC	60V AC	(not dewed) Note1	(not dewed) Note2

Applicable cable $t=0.30\pm0.05$, Tin-lead plating (Note 3)

Item	Specification	Conditions
1. Insulation Resistance	500M ohms min.	100V DC
2. Withstanding Voltage	No flashover or insulation breakdown.	0.3mm pitch: 90V AC 0.4mm pitch: 150V AC applied for one minute 0.5mm pitch: 200V AC
3. Contact Resistance	150m ohms max. *Including FPC conductor resistance.	1mA
4. Durability (Insertion/withdrawal)	150m ohms max. No damage, cracks, or parts dislocation.	20 cycles
5. Vibration	No electrical discontinuity of $1\mu s$ or more Contact resistance: 150m ohms max. No damage, cracks, or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 2 hours in each of the 3 directions.
6. Shock	No electrical discontinuity of 1 μ s or more Contact resistance: 150m ohms max. No damage, cracks, or parts dislocation.	Acceleration of 490 m/s², 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
7. Humidity (Steady state)	Contact resistance: 150m ohms max. Insulation resistance: 50M ohms min. No damage, cracks, or parts dislocation.	96 hours at temperature of 40°C and humidity of 90% to 95%
8. Temperature cycle	Contact resistance: 150m ohms max. Insulation resistance: 50M ohms min. No damage, cracks, or parts dislocation.	Temperature: $-40 \rightarrow +15$ to $35^{\circ}C \rightarrow +85^{\circ}C \rightarrow +15^{\circ}C$ to $35^{\circ}C$ Time : 30 minutes \rightarrow 5 minutes max. \rightarrow 30 minutes \rightarrow 5 minutes max. \rightarrow 5 cycles
9. Resistance to Soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350±5℃ for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers nonconducting condition of installed connectors in storage, shipment or during transportation.

Note 3: When FPC is gold plated, the connector contacts should be also gold plated: Select the (05) specification.

■Materials

Part	Material	Finish	Remarks	
Insulator	Polyamide	Color : Boigo		
insulator	LCP	Color : Beige	UL94V-0	
	PPS	Color : Dark brown		
Contact	Dhaanhanhaan	Tin-lead plating		
Contact	Phosphor bronze	Gold plating		

■Ordering Information

$$\frac{\text{FH}}{0} \frac{16}{0} - \frac{64S}{0} - \frac{0.5}{0} \frac{\text{SHW}}{0} \frac{(05)}{0}$$

1 Series name	: FH				
2 Series No.	: 16				
3 Number of contact	s: 50, 60, 64, 80, 90, and 96 contacts				
4 Contact pitch	: 0.3mm, 0.4mm, 0.5mm				
5 Terminal Shape	: SHW(SMT horizontal staggered row mount type)				
6 Plating Specification : No symbol : Tin-lead plating (05) : gold plating					

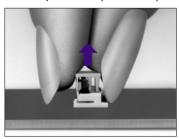
● Connector Operating Instructions, precautions and recommendations

1.FPC Termination procedure. Connector

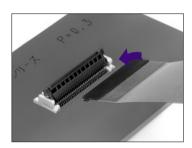
1) Remove and dispose the pick-and-place insert.

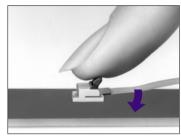
installed on the board.

Operation



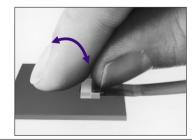
2) Rotate down the actuator until firmly closed. It is critical that the inserted FPC is not moved and remains fully inserted. Should the FPC be moved, open the actuator and repeat the process, starting with Step 1 above.





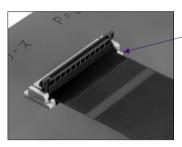
2.FPC Removal

- 1) Lift up the actuator.
- 2) Carefully remove the FPC.



1) Fully insert the FPC parallel to mounting surface, with the exposed conductive traces facing down.

Precautions



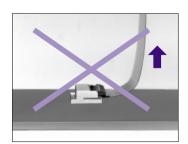
Positioning point

2) The connector will assure reliable performance when the actuator is open to 120° maximum (see fig.1) Do not exceed this angle, as this may cause permanent damage to the connector.

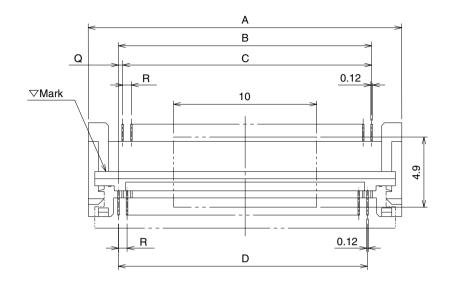


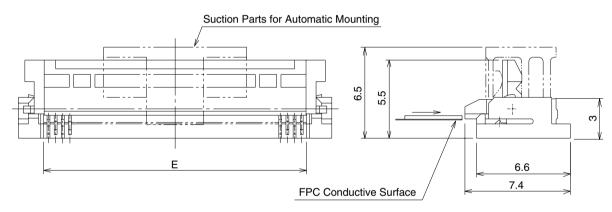
Fig.1

3) Do NOT push/pull actuator. Any damage to actuator will require replacement of the entire connector.



■Connector Dimensions



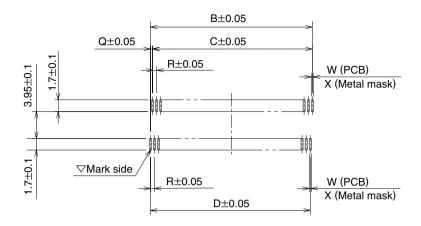


Unit: mm

Part Number	CL No.	Number of contacts	FPC Contact Pitch	А	В	С	D	E	Q	R
FH16-60S-0.3SHW	586-0620-2	60	0.3	21.9	17.7	17.4	17.4	18.35	0.3	0.6
FH16-80S-0.3SHW	586-0613-7	80	0.3	27.9	23.7	23.4	23.4	24.35	0.3	0.6
FH16-90S-0.3SHW	586-0697-7	90	0.3	30.9	26.7	26.4	26.4	27.35	0.3	0.6
FH16M-80S-0.4SHW	586-0675-4	80	0.4	36.1	31.6	31.2	31.2	32.25	0.4	0.8
FH16M-96S-0.4SHW	586-0715-7	96	0.4	42.5	38	37.6	37.6	38.65	0.4	0.8
FH16H-50S-0.5SHW	586-0676-7	50	0.5	29.4	24.5	24	24	25.55	0.5	1
FH16P-64S-0.5SHW	586-0649-4	64	0.5	36	31.5	31	31	32.15	0.5	1

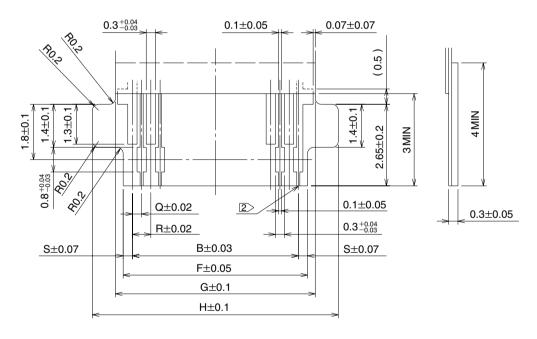
NOTE: Embossed tape reel packaging (1,000 pieces/reel). Order by number of reels.

♠ Recommended PCB layout and metal mask dimensions



* Recommended metal mask thickness: t=0.15

♦ FPC recommended dimensions



- 1 * Forced film material shall be polyamide + thermal hardened additives.
- 2 Conductor width shall be 0.1±0.05 if FPC has plating bars.

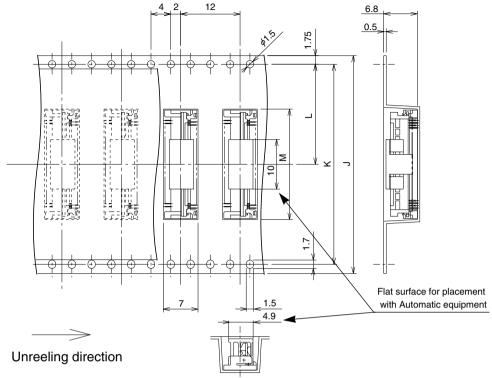
FPC, Land, Metal Mask Dimension Table

Unit: mm

Part Number	CL No.	Number of contacts	FPC Contact Pitch	В	С	D	F	G	Н	Q	R	S	W	Х
FH16-60S-0.3SHW	586-0620-2	60	0.3	17.7	17.4	17.4	18.3	18.8	20.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16-80S-0.3SHW	586-0613-7	80	0.3	23.7	23.4	23.4	24.3	24.8	26.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16-90S-0.3SHW	586-0697-7	90	0.3	26.7	26.4	26.4	27.3	27.8	29.3	0.3	0.6	0.3	0.3±0.03	0.25±0.03
FH16M-80S-0.4SHW	586-0675-4	80	0.4	31.6	31.2	31.2	32.2	32.7	34.2	0.4	8.0	0.3	0.3±0.03	0.25±0.03
FH16M-96S-0.4SHW	586-0715-7	96	0.4	38	37.6	37.6	38.6	39.1	40.6	0.4	8.0	0.3	0.3±0.03	0.25±0.03
FH16H-50S-0.5SHW	586-0676-7	50	0.5	24.5	24	24	25.5	25.5	27.5	0.5	1	0.5	0.6±0.1	0.5±0.05
FH16P-64S-0.5SHW	586-0649-4	64	0.5	31.5	31	31	32.1	32.6	34.1	0.5	1	0.3	0.6±0.1	0.5±0.05

● Packaging Specification

•Embossed Carrier Tape Dimensions

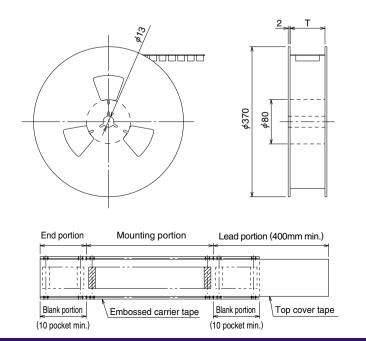


Unit: mm

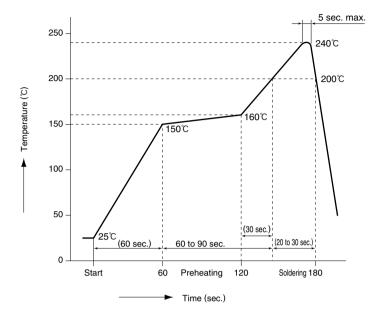
Inserted Connector	Number of Contacts	J	К	L	М	Т
FH16-60S-0.3SHW	60	44	40.4	20.2	22.3	44.5
FH16-80S-0.3SHW	80	44	40.4	20.2	28.3	44.5
FH16-90S-0.3SHW	90	44	40.4	20.2	31.3	44.5
FH16M-80S-0.4SHW	80	56	52.4	26.2	36.6	56.5
FH16M-96S-0.4SHW	96	56	52.4	26.2	43	56.5
FH16H-50S-0.5SHW	50	44	40.4	20.2	29.9	44.5
FH16P-64S-0.5SHW	64	56	52.4	26.2	36.6	56.5

NOTE: 1,000 pieces per reel.

Reel Dimensions



♠ Recommended Temperature Profile



HRS test conditions

Solder method :Reflow, IR/hot air

(Nihon Den-netsu Co., Ltd.'s

Part Number: SENSBY NR- II)

:Room air Environment

:Paste, 63%Sn/37%Pb Solder composition

> (Senju Metal Industry, Co., Ltd.'s Part Number: OZ63-201C-50-9)

Test board :Glass epoxy 45mm×80mm×1.6mm thick

Land dimensions :Contact Pitch 0.3mm, 0.4mm

> 0.3mm $\times 1.7$ mm Contact Pitch 0.5mm 0.6mm×1.7mm

Metal mask :Contact Pitch 0.3mm, 0.4mm

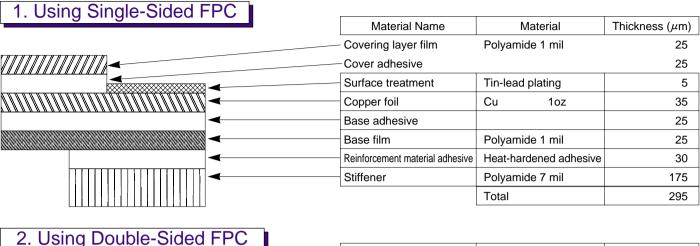
0.25mm $\times 1.7$ mm $\times 0.15$ mm thick

Contact Pitch 0.5mm

0.5mm×1.7mm×0.15mm thick

This temperature profile is based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

● FH16 Series FPC Construction (Recommended Specifications)



2. Using Double-Sided FPC	Material Name	Material	Thickness (µm)
	Covering layer film	Polyamide 1 mil	25
	Cover adhesive		25
4	Surface treatment	Tin-lead plating	5
	Through hole copper	Cu	15
<u> </u>	Copper foil	Cu 1/2 oz	18
-	Base adhesive		18
lacksquare	Base film	Polyamide 1 mil	25
	Base adhesive		18
<i>\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\</i>	Copper foil	Cu 1/2 oz	18
-	Cover adhesive		25
//////////////////////////////////////	Cover layer film	Polyamide 1 mil	25
<u> </u>	Reinforcement material adhesive	Heat-hardened adhesive	50
	Stiffener	Polyamide 1 mil	100
		Total	299

Note: To prevent release of the lock due to FPC bending, please do not use copper foil on the rear side.

3. Precautions

- 1. This specification is a recommendation for the construction of the FH16 Series FPC (t=0.3 ± 0.05).
- 2. The FH16 Series are connectors for thin FPC which is beginning to be used in cameras and other miniature equipment. Stiffener is not required for double-sided FPC which will be reflected in FPC cost reduction.

Please note that in the case of single-sided FPC, stiffener is required, but the thickness dimension can be created easily. For details about the construction, please contact the FPC manufacturer.

FPC Manufactures' Contact List

Sumitomo Bakelite Co., Ltd. Flexible Printed Circuit Board Division 5-8, Higashi-shinagawa 2-chome, Shinagawa-ku, Tokyo, Japan	TEL:+81 3 5462 4191 FAX:+81 3 5462 4882
Fujikura Ltd. Electronics Global Marketing Department 1-5-1, Kiba, Koto-ku, Tokyo, Japan	TEL:+81 3 5606 1165 FAX:+81 3 5606 1530
NOK Corporation Sales Division Overseas Business Department 1-12-15, Shiba-Daimon, Minato-ku, Tokyo, Japan	TEL:+81 3 3432 6976/8415 FAX:+81 3 3432 3919